

MicroPower Microprocessor Reset Circuit

Features

- 1.2V to 6V Input Voltage Range
- Low Quiescent Current : less Than 1.5 μ A
- High accuracy detection threshold : $\pm 1.5\%$
- Fixed trimmed reset thresholds for 1.5V, 1.75V , 2.32V, 2.63V, 2.93V, 3.08V, 3.9V, 4.38V.
- Reset Timeout Period 250ms
- Available output configurations
 - Open-drain output
 - CMOS active high output
 - CMOS active low output
- SOT-23 , SOT-23-5 and SOT-89 packages
- No external components

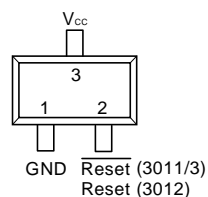
Applications

- Computers
- Cell Phones
- Portable Electronics
- μ P Power Supply Monitoring

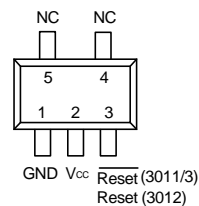
General Description

The APR3011/2/3 are designed to monitor voltage supplies in μ P and digital systems. The quiescent current is extremely low, typically 1.5 μ A, making it ideal for portable battery operated equipment. The APR3011/2/3 operate by monitoring the system power supply voltage. When the input voltage drops below a fixed threshold, the device asserts a reset signal for a fixed time period after V_{cc} rises above the fixed threshold. The APR3011/2/3 series is available with three output stage versions : APR3011 push-pull active low output, APR3012 push-pull active high output and APR3013 open drain active low output. They are also designed to reject fast line transient glitches on V_{cc} . The APR3011/2/3 are come in a miniature SOT-23, SOT-23-5, SOT-89 packages.

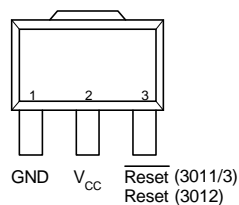
Pin Configuration



SOT-23 (Top View)



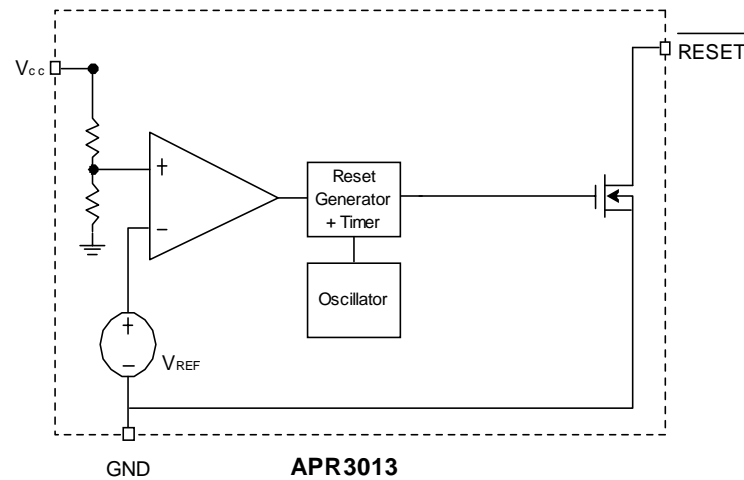
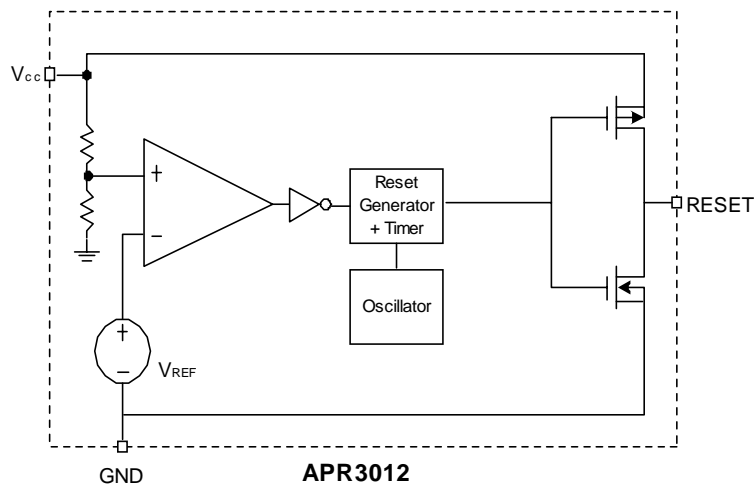
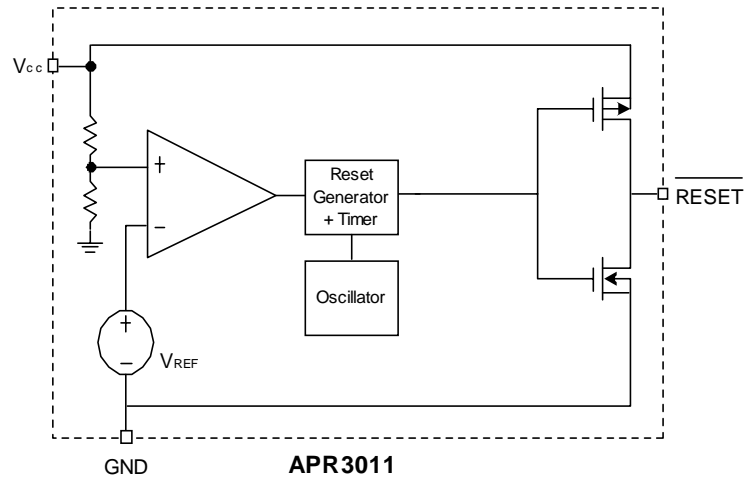
SOT-23-5 (Top View)



SOT-89 (Top View)

ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Block Diagram



Part Number Description

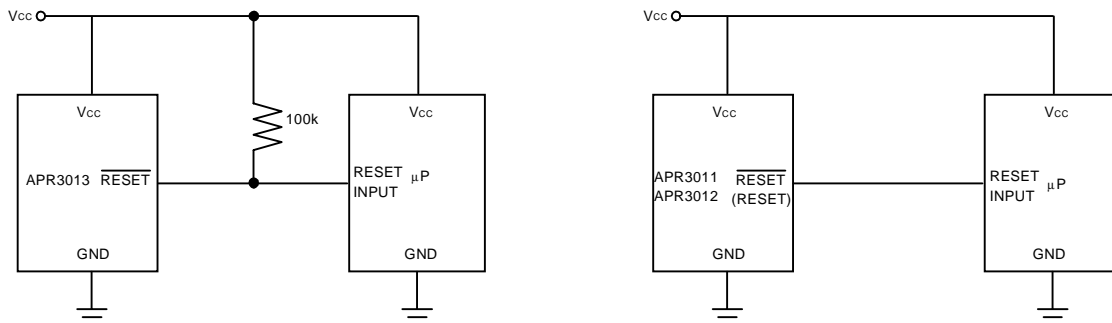
Part Number	Part Description
APR3011	Reset Output Push Pull Active Low with Delay
APR3012	Reset Output Push Pull Active High with Delay
APR3013	Reset Output Open Drain Active Low with Delay

Electrical Characteristics

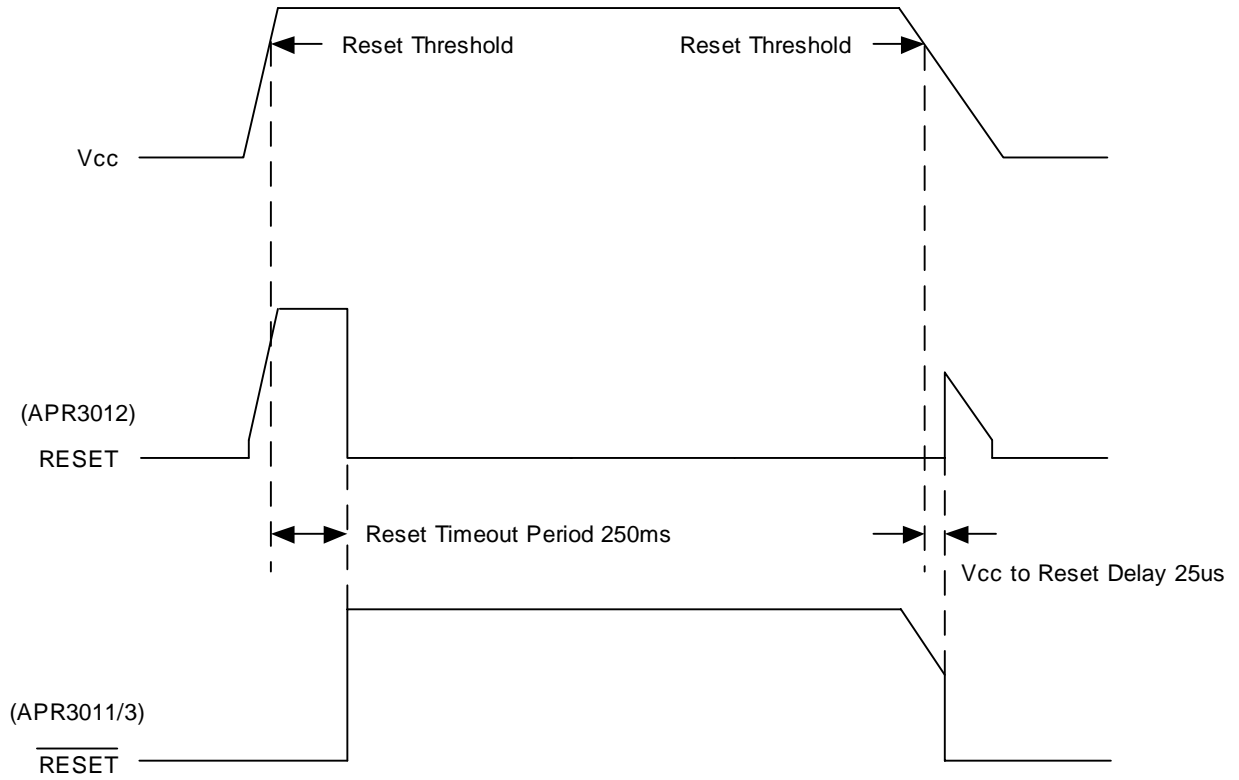
$V_{IN} = 5V$, $T_A = -40$ to $85^{\circ}C$ unless otherwise noted. Typical values are at $T_A=25^{\circ}C$, $V_{CC} = 5V$ for 4.38V versions, $V_{CC} = 3.3V$ for 3.08/2.93V versions, $V_{CC} = 3.0V$ for 2.63V. versions and $V_{CC} = 2.5V$ for 2.32V versions, $V_{CC} = 2.0V$ for 1.75V versions , $V_{CC} = 1.8V$ for 1.5V versions.

Symbol	Parameter	Test Conditions	APR3011/2/3			Unit
			Min.	Typ.	Max.	
V_{CC}	Supply Voltage		1.2		6	V
I_{CC}	Supply Current	$V_{CC}=1.5V\sim 6V$		1.5	4	μA
		$T_A=-40$ to $85^{\circ}C$		3	5	
V_{TH}	Reset Threshold	$T_A=25^{\circ}C$		$\pm 1.5\%$		
		$T_A=-40$ to $85^{\circ}C$		$\pm 2\%$		
V_{HYST}	Hysteresis Range			20		mV
T_{RTP}	Reset Timeout Period		150	250	350	ms
V_{OL}	Reset Output Low	$I_{SINK}=1.2mA$			0.5	V
V_{OH}	Reset Output High	$I_{SOURCE}=0.6mA$	$0.8*V_{CC}$			
T_D	V_{CC} to Reset Delay	$V_{CC}=V_{TH}$ to $(V_{TH}-100mV)$		25		μS
I_{LE}	Reset Output Leakage				0.5	μA

Application Circuit

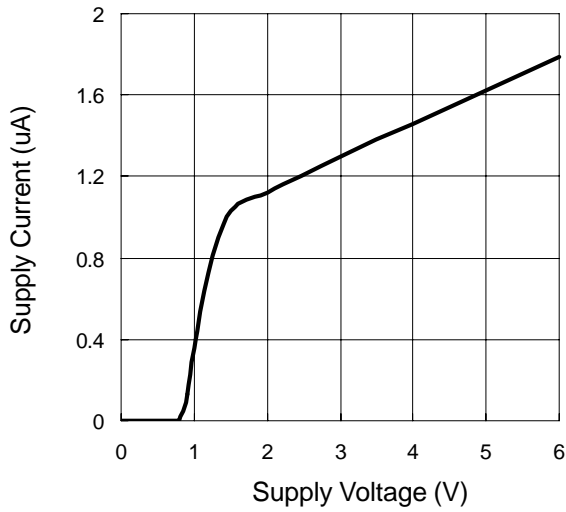


Timing Chart

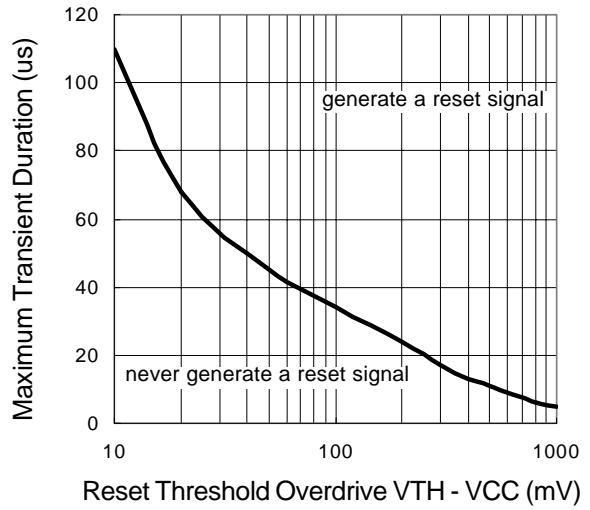


Typical Characteristics

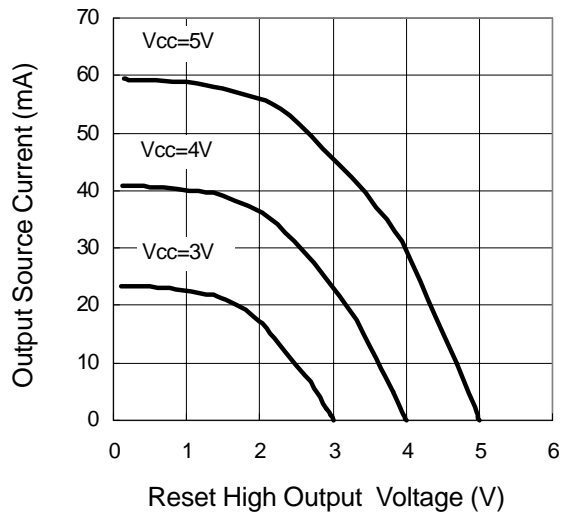
Supply Current vs. Supply Voltage



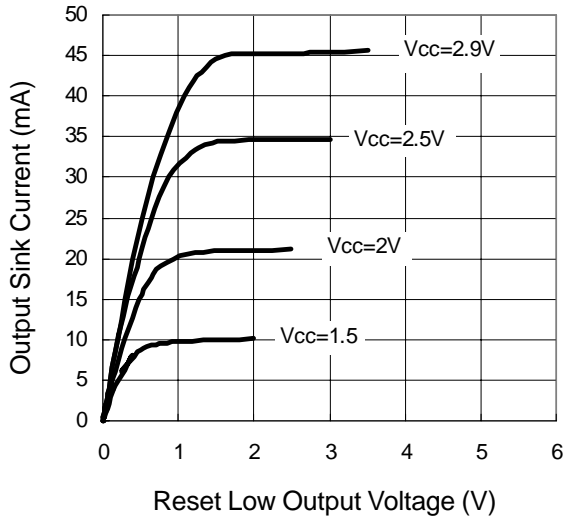
Maximum Transient Duration vs. Reset Threshold Overdrive $V_{TH} - V_{CC}$



Output Source Current vs. Reset High Output Voltage

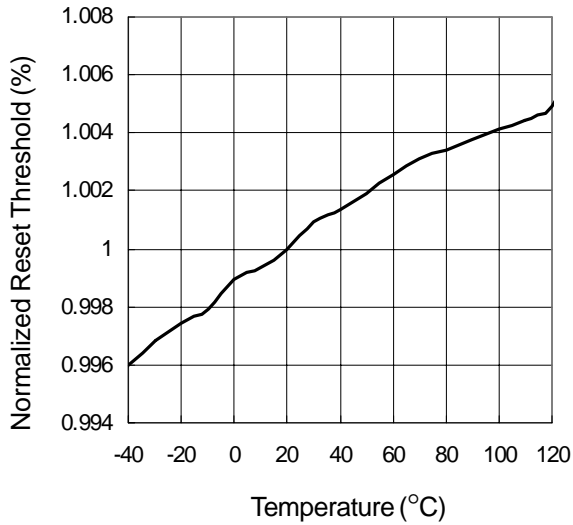


Output Sink Current vs. Reset Low Output Voltage

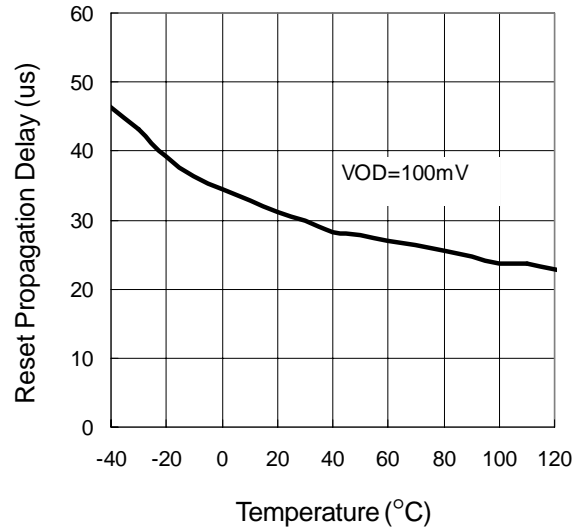


Typical Characteristics

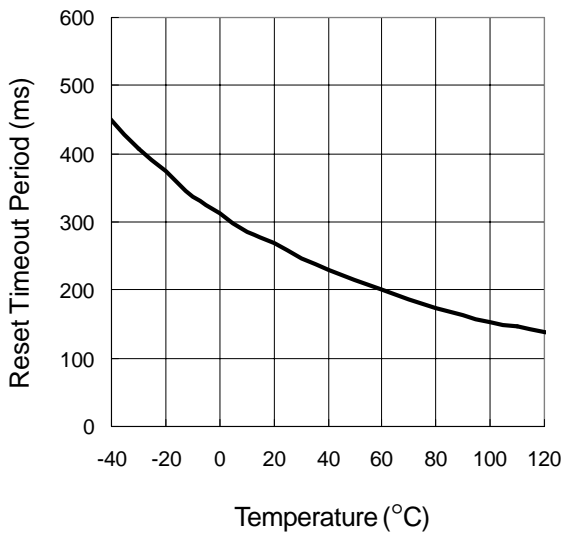
Normalized Reset Threshold vs. Temperature



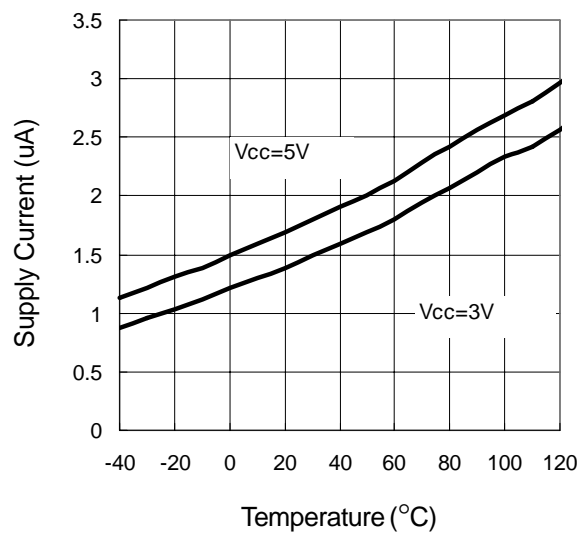
Reset Propagation Delay vs. Temperature



Reset Timeout Period vs. Temperature

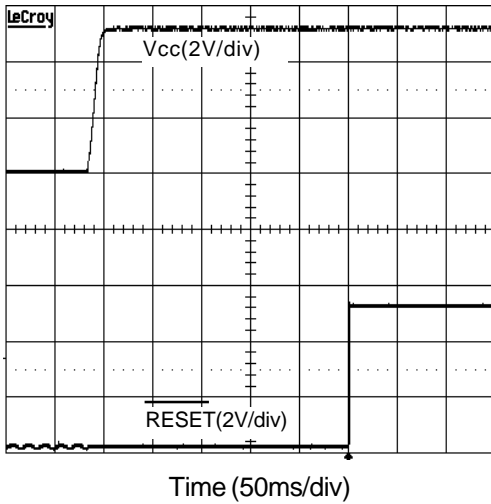


Supply Current vs. Temperature

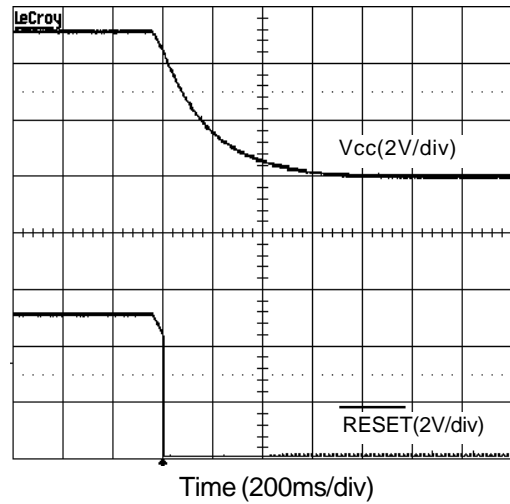


Typical Characteristics

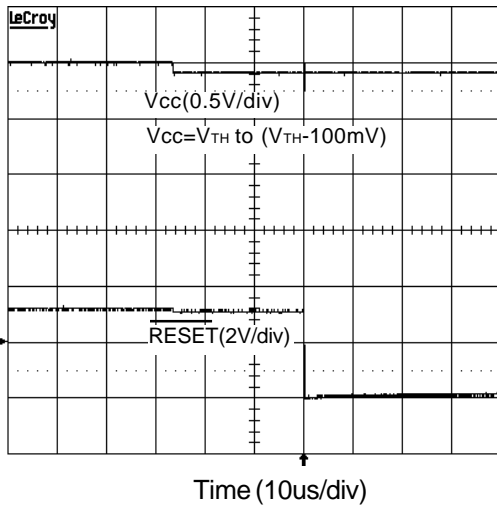
Power Up



Power Down



Vcc to RESET Delay



Application Information

V_{CC} Transient Rejection

The APR3011/2/3 have the function to reject the transient glitches from the power line. The Maximum Transient Duration vs. Reset Threshold Overdrive shows at Typical Characteristics. The transient voltage with the duration under the curve will not generate a reset signal, e.g. a transient of 100mV below the reset threshold voltage have the duration more than 35us, it will generate a reset signal. Connect a 0.1uF bypass capacitor to the V_{CC} pin can improve the transient immunity.

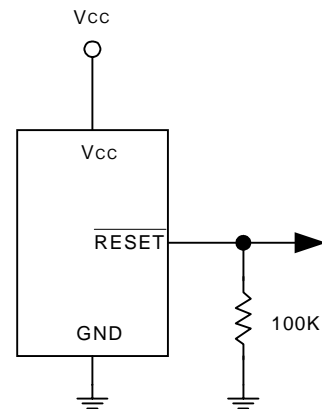


Figure 1. Ensuring $\overline{\text{RESET}}$ Valid to V_{CC} = 0 V

Reset Output

The APR3011/2/3 have 3 output stage versions: APR3001 is an active low push-pull output, when the V_{CC} drops below the reset threshold, the RESET output generates a low signal. APR3012 is an active high push-pull output, when the V_{CC} drops below the reset threshold, the RESET output generates a high signal (see Timing Chart). APR3013 is an active low open drain output, the $\overline{\text{RESET}}$ output must be connected a pull-up resistor to a supply voltage that is lower than 6V, it suits to use in multiple voltage systems (see Figure 2). The APR3011 $\overline{\text{RESET}}$ output is valid until the V_{CC}=1.2V, below 1.2V the IC is shutdown, and the output becomes a floating state. If it is a trouble, a resistor should be connected from reset output to ground to keep the reset output low (see Figure 1). For The APR3012, a pull-up resistor to V_{CC} is required to keep the valid reset output for V_{CC} below 1.2V.

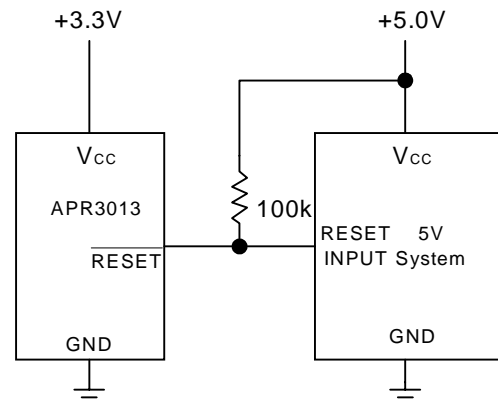
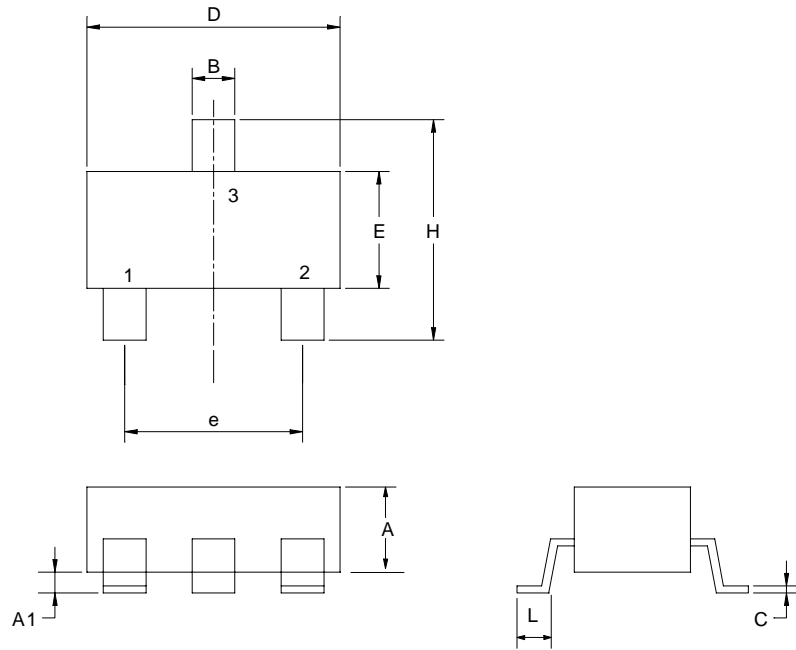


Figure 2. APR3013 Open Drain Output with Multiple Supplies

Packaging Information

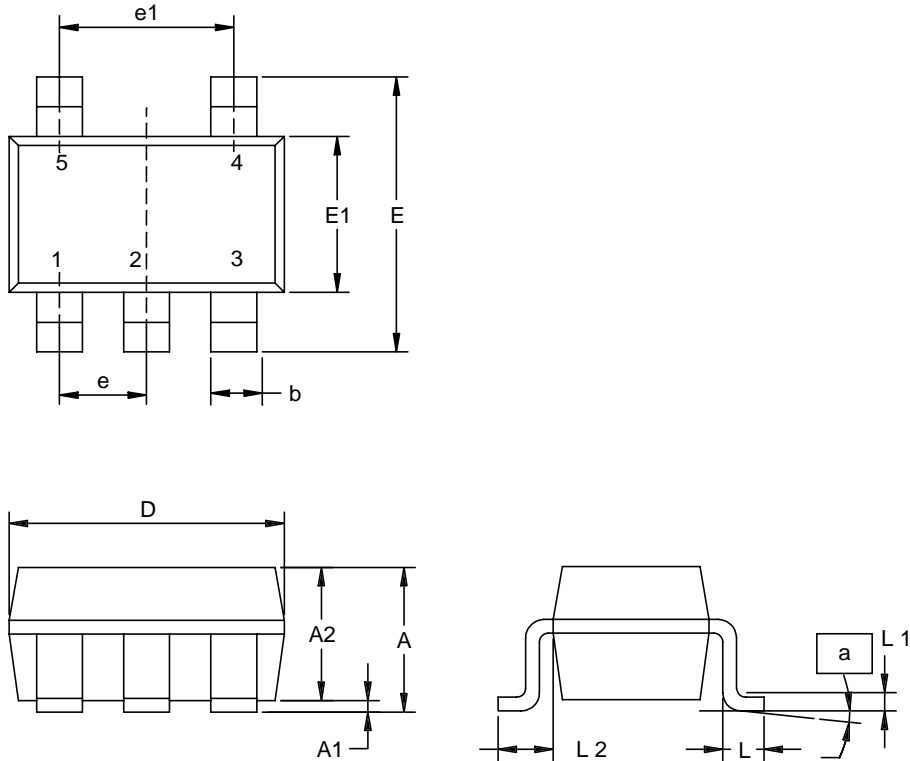
SOT-23



Dim	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
B	0.35	0.51	0.014	0.020
C	0.10	0.25	0.004	0.010
D	2.70	3.10	0.106	0.122
E	1.40	1.80	0.055	0.071
e	1.90/2.1 BSC		0.075/0.083 BSC	
H	2.40	3.00	0.094	0.118
L	0.37		0.015	

Packaging Information

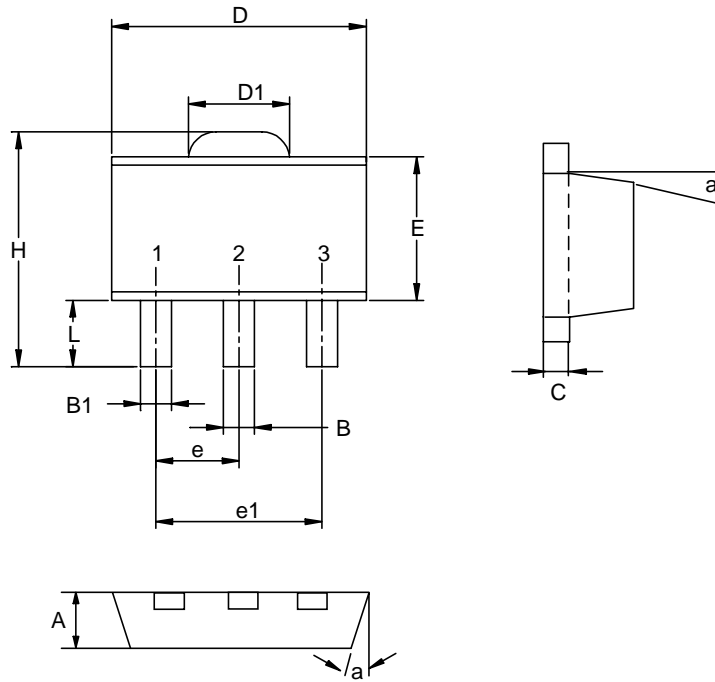
SOT-23-5



Dim	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.95	1.45	0.037	0.057
A1	0.05	0.15	0.002	0.006
A2	0.90	1.30	0.035	0.051
b	0.30	0.50	0.011	0.019
D	2.8	3.00	0.110	0.118
E	2.6	3.00	0.102	0.118
E1	1.5	1.70	0.059	0.067
e	0.95BSC		0.037BSC	
e1	1.90BSC		0.074BSC	
L	0.35	0.55	0.014	0.022
L1	0.20 BSC		0.008 BSC	
L2	0.5	0.7	0.020	0.028
N	5		5	
α	0°	10°	0°	10°

Packaging Information

SOT-89 (Reference EIAJ ED-7500A Registration SC-62)

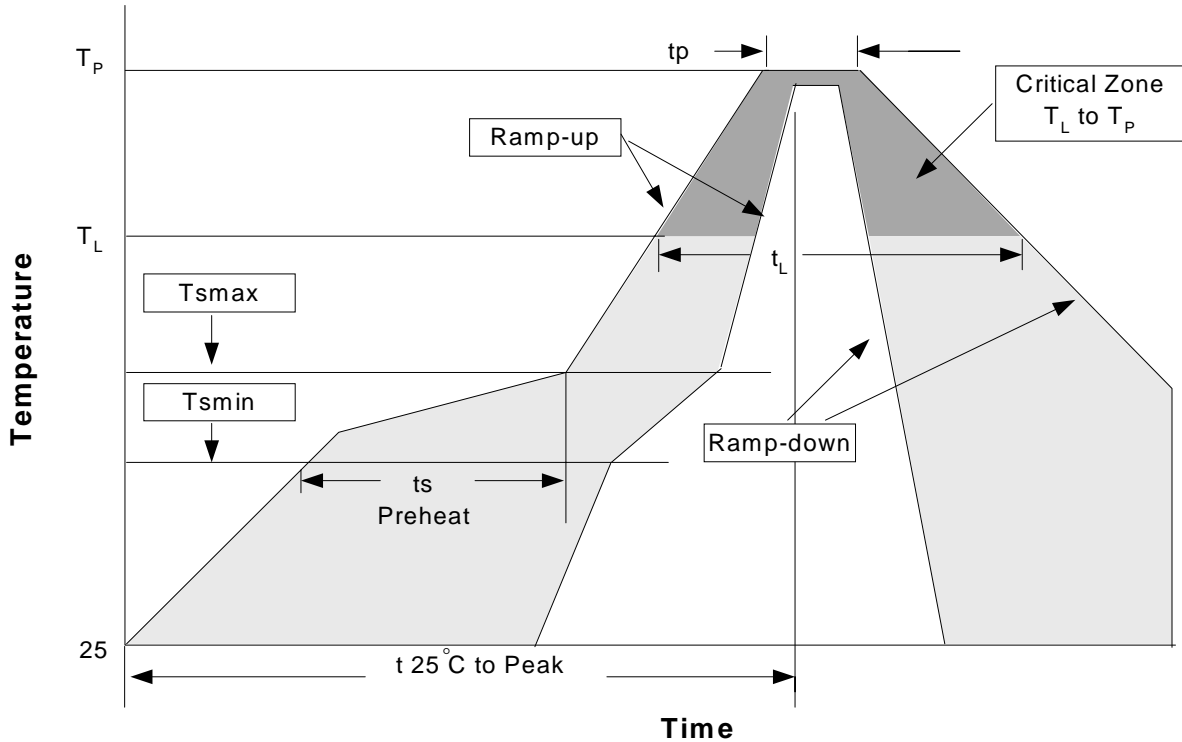


Dim	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.40	1.60	0.055	0.063
B	0.40	0.56	0.016	0.022
B1	0.35	0.48	0.014	0.019
C	0.35	0.44	0.014	0.017
D	4.40	4.60	0.173	0.181
D1	1.35	1.83	0.053	0.072
e	1.50 BSC		0.059 BSC	
e1	3.00 BSC		0.118 BSC	
E	2.29	2.60	0.090	0.102
H	3.75	4.25	0.148	0.167
L	0.80	1.20	0.031	0.047
α		10°		10°

Physical Specifications

Terminal Material	Solder-Plated Copper (Solder Material : 90/10 or 63/37 SnPb), 100%Sn
Lead Solderability	Meets EIA Specification RSI86-91, ANSI/J-STD-002 Category 3.

Reflow Condition (IR/Convection or VPR Reflow)



Classification Reflow Profiles

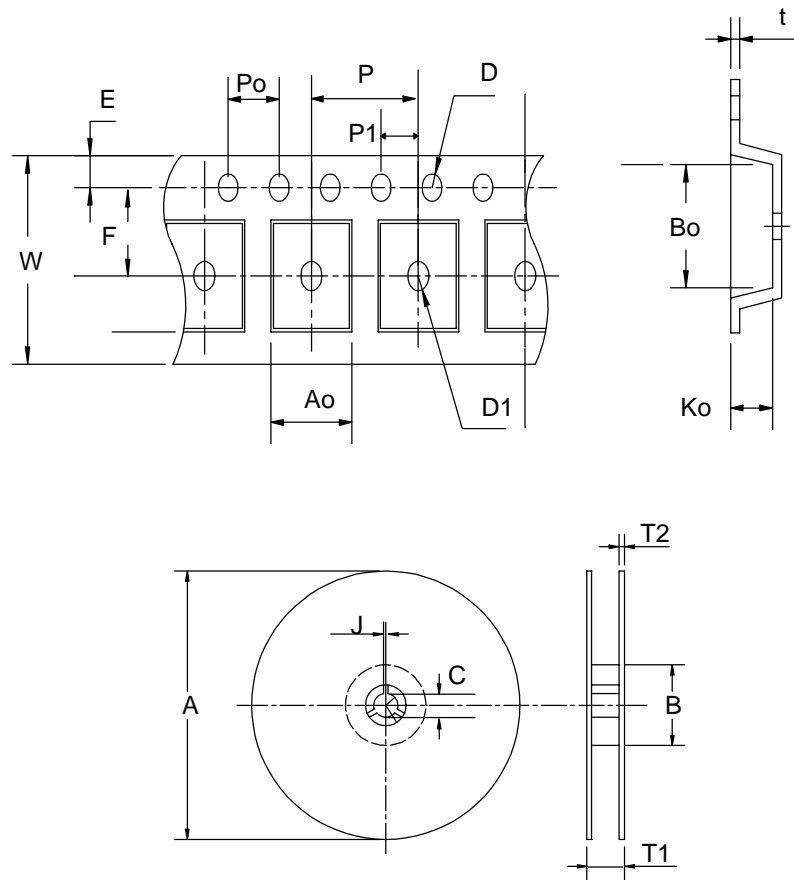
Profile Feature	Sn-Pb Eutectic Assembly		Pb-Free Assembly	
	Large Body	Small Body	Large Body	Small Body
Average ramp-up rate (T_L to T_P)	3°C/second max.		3°C/second max.	
Preheat				
- Temperature Min (T_{smin})	100°C		150°C	
- Temperature Mix (T_{smax})	150°C		200°C	
- Time (min to max)(t_s)	60-120 seconds		60-180 seconds	
T_{smax} to T_L				
- Ramp-up Rate			3°C/second max	
T_{smax} to T_L				
- Temperature(T_L)	183°C		217°C	
- Time (t_L)	60-150 seconds		60-150 seconds	
Peak Temperature(T_p)	225 +0/-5°C	240 +0/-5°C	245 +0/-5°C	250 +0/-5°C
Time within 5°C of actual Peak Temperature(t_p)	10-30 seconds	10-30 seconds	10-30 seconds	20-40 seconds
Ramp-down Rate	6°C/second max.		6°C/second max.	
Time 25°C to Peak Temperature	6 minutes max.		8 minutes max.	

Note: All temperatures refer to topside of the package. Measured on the body surface.

Reliability test program

Test item	Method	Description
SOLDERABILITY	MIL-STD-883D-2003	245°C, 5 SEC
HOLT	MIL-STD-883D-1005.7	1000 Hrs Bias @125°C
PCT	JESD-22-B,A102	168 Hrs, 100%RH, 121°C
TST	MIL-STD-883D-1011.9	-65°C~150°C, 200 Cycles
ESD	MIL-STD-883D-3015.7	VHBM > 2KV, VMM > 200V
Latch-Up	JESD 78	10ms, $1_{tr} > 100mA$

Carrier Tape & Reel Dimensions



Carrier Tape & Reel Dimensions

Application	A	B	C	J	T1	T2	W	P	E
SOT-23	178±1	60 ± 1.0	12.0	2.5 ± 0.15	9.0 ± 0.5	1.4	8.0 ^{+0.3} _{-0.3}	4.0	1.75
	F	D	D1	Po	P1	Ao	Bo	Ko	t
	3.5 ± 0.05	1.5 +0.1	φ 0.1MIN	4.0	2.0 ± 0.05	3.1	3.0	1.3	0.2±0.03
Application	A	B	C	J	T1	T2	W	P	E
SOT-23-5	178 ± 1	72 ± 1.0	13.0 + 0.2	2.5 ± 0.15	8.4 ± 2	1.5 ± 0.3	8.0 ± 0.3	4 ± 0.1	1.75± 0.1
	F	D	D1	Po	P1	Ao	Bo	Ko	t
	3.5 ± 0.05	1.5± 0.1	1.5± 0.1	4.0 ± 0.1	2.0 ± 0.1	3.15 ± 0.1	3.2± 0.1	1.4± 0.1	0.2±0.033
Application	A	B	C	J	T1	T2	W	P	E
SOT-89	178 ± 1	70 ± 2	13.5 ± 0.15	3 ± 0.15	14 ± 2	1.3 ± 0.3	12 ^{+0.3} _{12-0.1}	8 ± 0.1	1.75± 0.1
	F	D	D1	Po	P1	Ao	Bo	Ko	t
	5.5 ± 0.05	1.5± 0.1	1.5± 0.1	4.0 ± 0.1	2.0 ± 0.1	4.8 ± 0.1	4.5± 0.1	1.80± 0.1	0.3±0.013

(mm)

Cover Tape Dimensions

Application	Carrier Width	Cover Tape Width	Devices Per Reel
SOT- 23	8	5.3	3000
SOT- 23-5	8	5.3	3000
SOT- 89	12	9.3	1000

Customer Service

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